

# JMTK90N02AN

### Description

Features	Applications	RoHS	
• 20V, 90A	Load Switch		
$R_{DS(ON)}$ < 3.6m $\Omega$ @ $V_{GS}$ = 4.5V	PWM Application		
$R_{DS(ON)} < 4.9 m\Omega @ V_{GS} = 2.5 V$	Power Management		
Lead free and Green Device Available			
• Excellent R <sub>DS(ON)</sub> and Low Gate Charge	<sup>ge</sup> 100% UIS TESTED!		
Lead Free	100% ΔVds TEST	TED!	
D		GOLIN	
G 🎽 S TO-252-3L Top View	G D S Marking and Pin Assignment	Schematic Diagram	

# Device MarkingDeviceOutlinePackageReel SizeReel(pcs)Per Carton<br/>(pcs)JMTK90N02AJMTK90N02ANTAPINGTO-252-3L13"250025000

#### Absolute Maximum Ratings (@ $T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V <sub>DS</sub>	Drain-to-Source Voltage		20	V
V <sub>GS</sub>	Gate-to-Source Voltage		±12	V
	Continuous Drain Current	T <sub>C</sub> = 25°C	90	A
Ι <sub>D</sub>		T <sub>C</sub> = 100°C	57	
I <sub>DM</sub>	Pulsed Drain Current <sup>(1)</sup>		360	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy note2		156	mJ
P <sub>D</sub>	Power Dissipation	$T_c = 25^{\circ}C$	54	W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient <sup>(2)</sup>		32	°C/W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case <sup>(3)</sup>		2.32	°C/W
$T_{J}, T_{STG}$	Junction & Storage Temperature Range		-55 to 150	°C



#### Electrical Characteristics (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics					•
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 $\mu$ A, V <sub>GS</sub> = 0V	20	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V	-	-	1.0	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Cha	racteristics			-		
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.5	0.8	1.0	V
	Static Drain-Source ON-Resistance <sup>(3)</sup>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =30A	-	2.8	3.6	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> = 2.5V, I <sub>D</sub> =20A	-	3.8	4.9	mΩ
Dynam	ic Characteristics				•	•
C <sub>iss</sub>	Input Capacitance		-	3476	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{GS} = 0V, V_{DS} = 10V,$	-	528	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz	-	464	-	pF
Qg	Total Gate Charge		-	65	-	nC
Q <sub>gs</sub>	Gate Source Charge	$V_{GS} = 0$ to 8V	-	8	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	$V_{\rm DS} = 10V, I_{\rm D} = 30A$	-	12	-	nC
Switch	ing Characteristics		-	•	1	T
t <sub>d(on)</sub>	Turn-On DelayTime		-	8	-	ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> = 10V, V <sub>DD</sub> = 10V	-	19	-	ns
t <sub>d(off)</sub>	Turn-Off DelayTime	I <sub>D</sub> = 30A, R <sub>GEN</sub> = 3Ω	-	73	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	80	-	ns
Drain-S	ource Diode Characteristics and	Max Ratings				
ls	Maximum Continuous Drain to Source Diode Forward Current			-	90	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current			-	360	Α
$V_{\text{SD}}$	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 30A	-	-	1.2	V
trr	Reverse Recovery Time	I <sub>F</sub> =20A,di/dt =100A/µs	-	16	-	ns
Qrr	Reverse Recovery Charge	$r_F = 20A$ , ui/ut = 100A/µS	-	5.6	-	nC

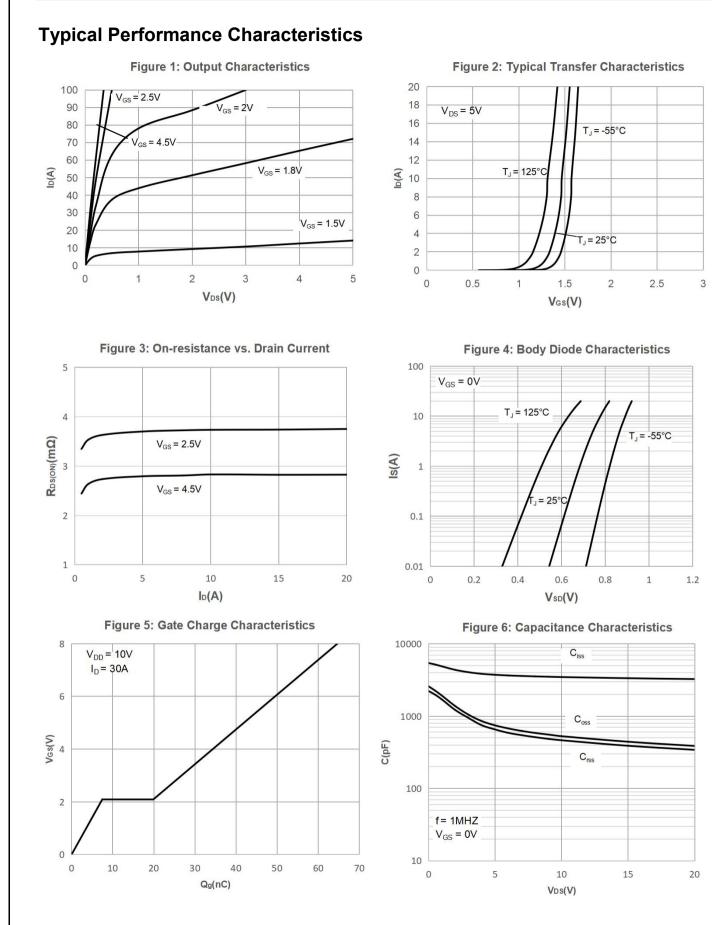
Notes: 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2.  $E_{AS}$  condition: Starting  $T_J$ =25  $^\circ\!\!\mathrm{C}$  ,  $V_{DD}$ =10V,  $V_G$ =10V,  $R_G$ =25 $\Omega,$  L=0.5mH,  $I_{AS}$ =25A .

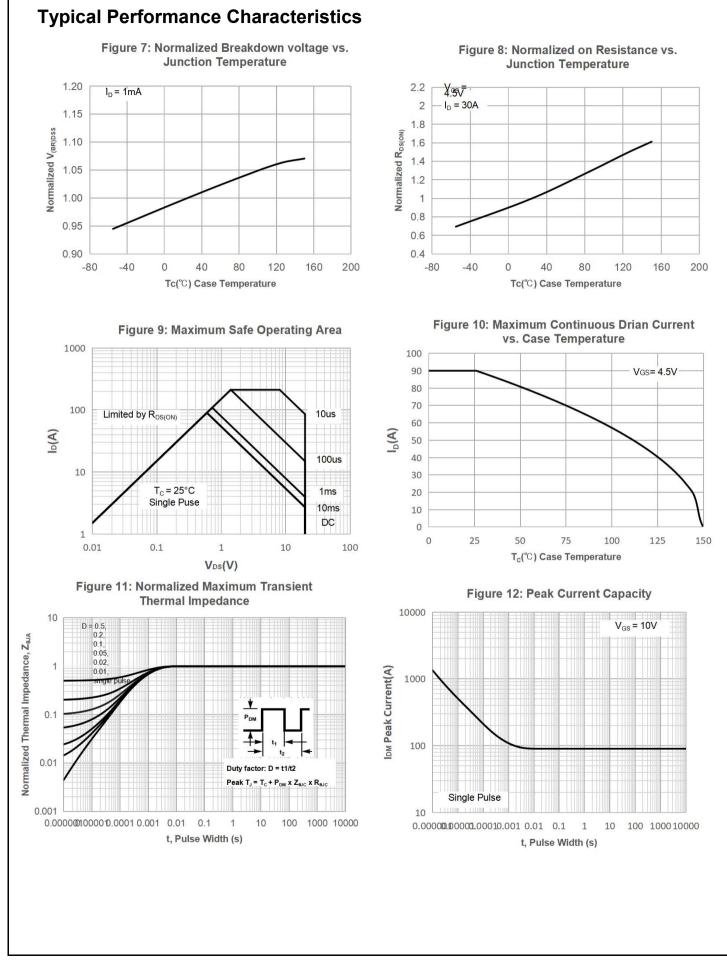
3.  $R_{\rm \theta JA}$  is measured with the device mounted on a 1inch^2 pad of 2oz copper FR4 PCB

4. Pulse Test: Pulse Width  ${\leqslant}300\mu s,$  Duty Cycle  ${\leqslant}0.5\%.$ 





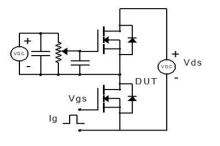






# JMTK90N02AN

## **Test Circuit**



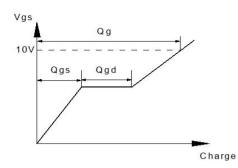


Figure 1: Gate Charge Test Circuit & Waveform

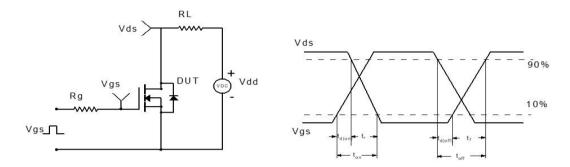


Figure 2: Resistive Switching Test Circuit & Waveform

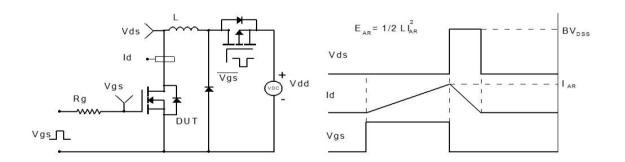
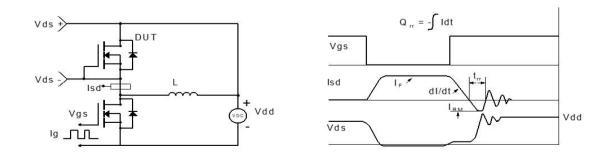


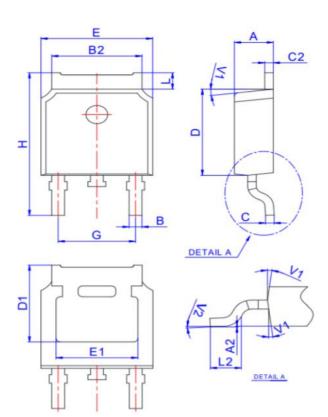
Figure 3: Unclamped Inductive Switching Test Circuit& Waveform







## Package Mechanical Data(TO-252-3L)



	Dimensions						
Ref.	Millimeters			Inches			
	Min.	Typ.	Max.	Min.	Тур.	Max.	
Α	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
С	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1	5.30REF			0.209REF			
Е	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°		6°	

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